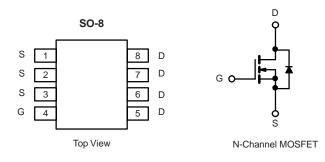


N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)		
60	0.025 at V _{GS} = 10 V	7.6	10.5 nC		
00	0.030 at V _{GS} = 4.5 V	6.5	10.3 HC		

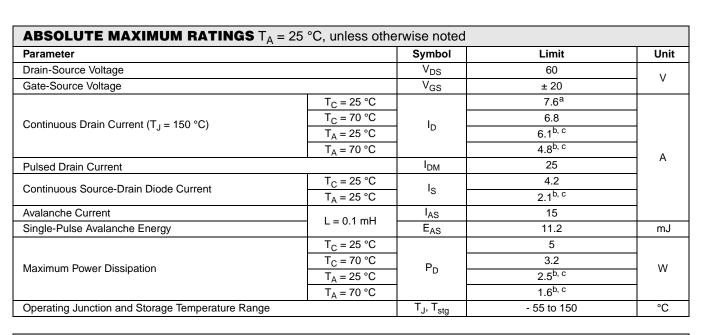


FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- Optimized for "Low Side" Synchronous Rectifier Operation
- 100 % R_a and UIS Tested

APPLICATIONS

• CCFL Inverter



THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	20	25	0/00	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 °C/W.



HALOGEN

Available

SPECIFICATIONS T _J = 25 °C Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-,			-76-			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			55		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6.3			
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1.2		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
-		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 10 V$	25			Α	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.6 \text{ A}$		0.025	0.030	-	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 4.2 A		0.035	0.040	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 4.6 A		20		S	
Dynamic ^b				1	•	1	
Input Capacitance	C _{iss}			1100		pF	
Output Capacitance	C _{oss}	V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz		90			
Reverse Transfer Capacitance	C _{rss}			55			
Tatal Oata Ohanna	V _{DS} :	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 4.6 \text{ A}$		21	32	nC	
otal Gate Charge				10.5	16		
Gate-Source Charge	Q _{gs}	$V_{DS} = 30$ V, $V_{GS} = 4.5$ V, $I_{D} = 4.6$ A		3.5			
Gate-Drain Charge	Q _{qd}			4.2			
Gate Resistance	R _a	f = 1 MHz		3.3	5	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = 30 V, R_L = 5.4 Ω		150	225	1	
Turn-Off DelayTime	t _{d(off)}	${\sf I}_{\sf D}\cong$ 5.6 A, ${\sf V}_{\sf GEN}$ = 4.5 V, ${\sf R}_{\sf g}$ = 1 Ω		20	30		
Fall Time	t _f	Ğ		60	90		
Turn-On Delay Time	t _{d(on)}			10	15	ns	
Rise Time	t _r	V_{DD} = 30 V, R_L = 5.4 Ω		15	25	-	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 5.6 \text{ A}, \text{ V}_{\text{GEN}}$ = 10 V, R_g = 1 Ω		25	40		
Fall Time	t _f	C C		10	15		
Drain-Source Body Diode Characterist	ics						
Continous Source-Drain Diode Current	۱ _S	T _C = 25 °C			4.2	٨	
Pulse Diode Forward Currenta	I _{SM}				25	A	
Body Diode Voltage	V _{SD}	I _S = 2 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			25	50	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			25	50	nC	
Reverse Recovery Fall Time	t _a	I _F = 5.5 A, dl/dt = 100 A/μs, T _J = 25 °C		19			
Reverse Recovery Rise Time t _b				6		ns	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

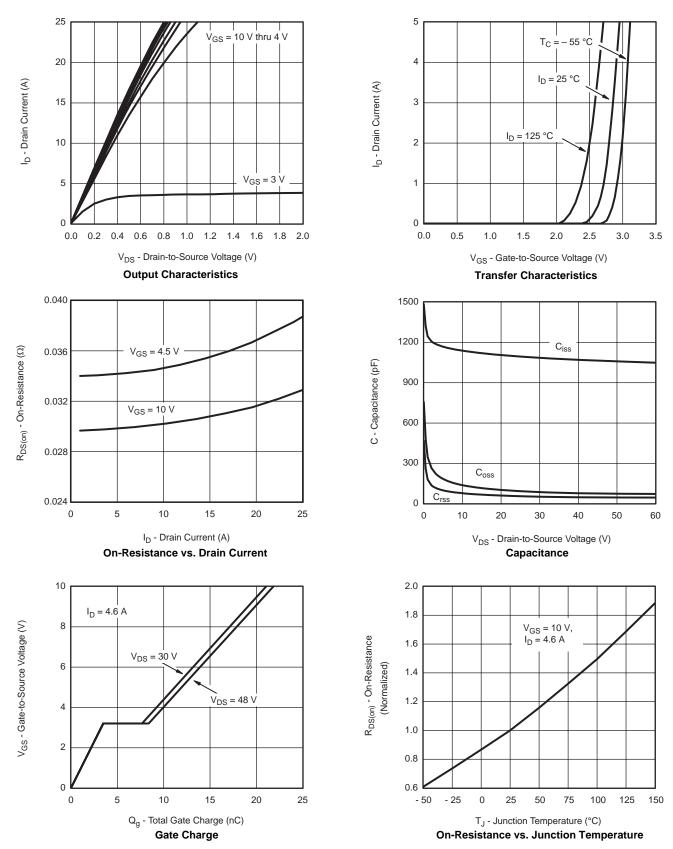
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

emi

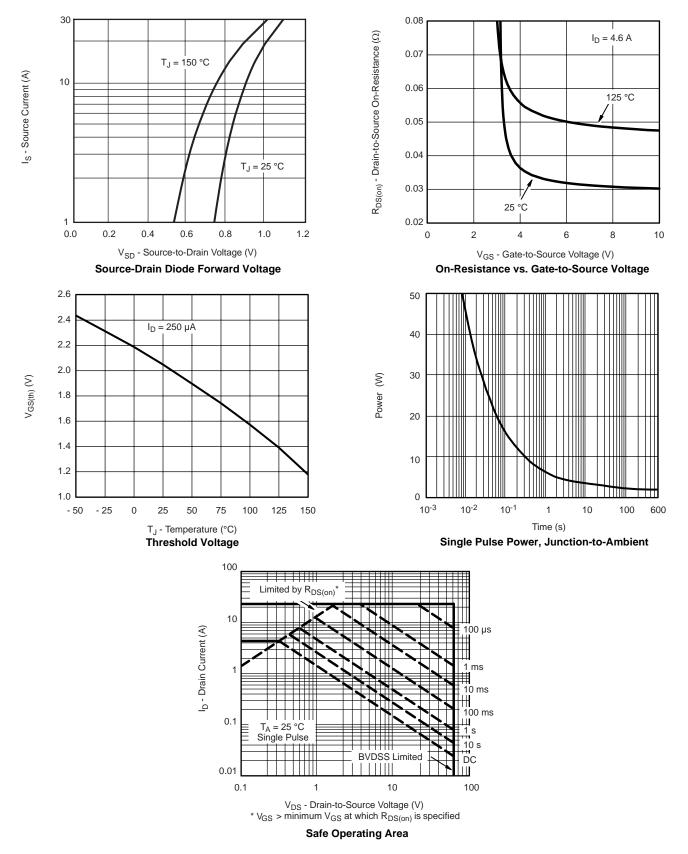






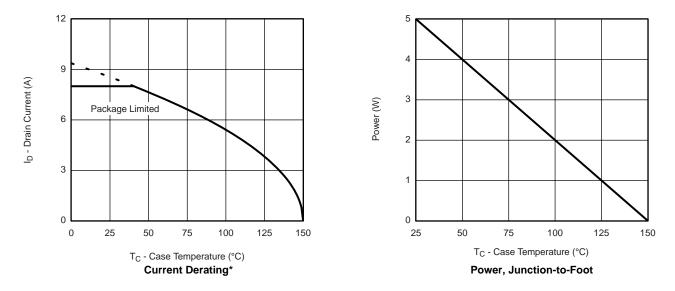


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

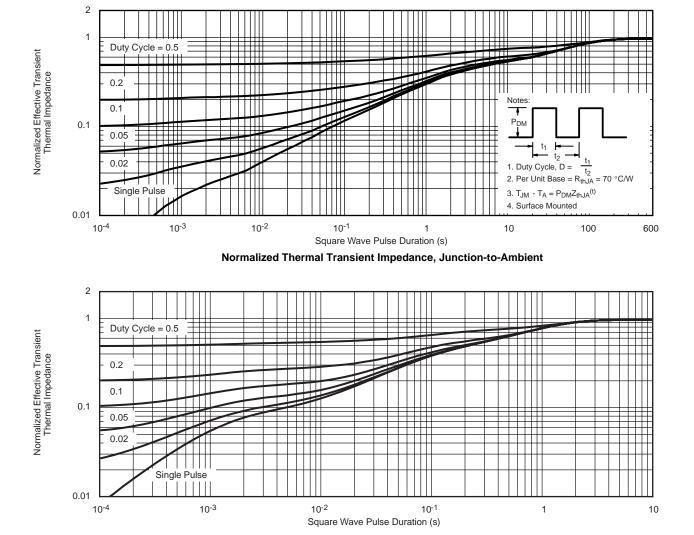




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot

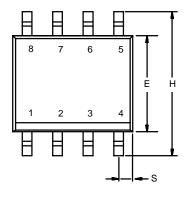
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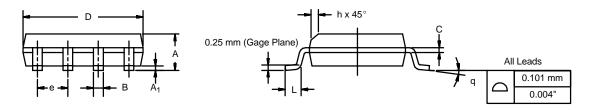
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SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

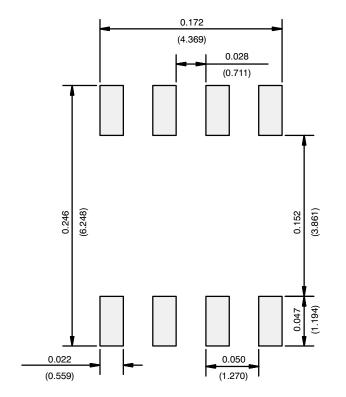




	MILLIMETERS		INC	HES	
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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